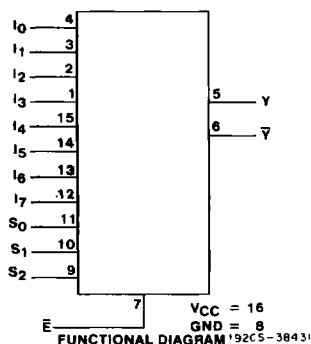


Advance Information



8-Input Multiplexer

Type Features:

- Buffered inputs
- Typical propagation delay:
6 ns @ $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{ C}$, $C_L = 50\text{ pF}$

The RCA CD54/74AC151 and CD54/74ACT151 8-input digital multiplexers use the RCA ADVANCED CMOS technology. They have three binary control inputs (S0, S1, and S2) and an active-LOW Enable (\bar{E}) input. The three binary inputs select 1 of 8 channels. The output is both inverting (\bar{Y}) and non inverting (Y).

The CD74AC151 and CD74ACT151 are supplied in 16-lead dual-in-line plastic packages (E suffix) and in 16-lead dual-in-line small-outline plastic packages (M suffix). Both package types are operable over the following temperature ranges: Commercial (0 to 70°C); Industrial (-40 to +85°C); and Extended Industrial/Military (-55 to +125°C).

The CD54AC151 and CD54ACT151, available in chip form (H suffix), are operable over the -55 to +125°C temperature range.

Family Features:

- Exceeds 2-kV ESD Protection - MIL-STD-883, Method 3015
- SCR-Latchup-resistant CMOS process and circuit design
- Speed of bipolar FAST*/AS/S with significantly reduced power consumption
- Balanced propagation delays
- AC types feature 1.5-V to 5.5-V operation and balanced noise immunity at 30% of the supply
- ± 24-mA output drive current
 - Fanout to 15 FAST* ICs
 - Drives 50-ohm transmission lines

*FAST is a Registered Trademark of Fairchild Semiconductor Corp.

INPUTS											OUTPUTS		
\bar{E}	S ₂	S ₁	S ₀	I ₀	I ₁	I ₂	I ₃	I ₄	I ₅	I ₆	I ₇	\bar{Y}	Y
H	X	X	X	X	X	X	X	X	X	X	X	H	L
L	L	L	L	L	X	X	X	X	X	X	X	H	L
L	L	L	L	H	X	X	X	X	X	X	X	L	H
L	L	L	H	X	L	X	X	X	X	X	X	H	L
L	L	L	H	X	H	X	X	X	X	X	X	L	H
L	L	H	L	X	X	L	X	X	X	X	X	H	L
L	L	H	L	X	X	H	X	X	X	X	X	L	H
L	L	H	H	X	X	X	L	X	X	X	X	H	L
L	L	H	H	X	X	X	H	X	X	X	X	L	H
L	H	L	L	X	X	X	X	L	X	X	X	H	L
L	H	L	L	X	X	X	X	H	X	X	X	L	H
L	H	L	H	X	X	X	X	X	L	X	X	H	L
L	H	L	H	X	X	X	X	X	H	X	X	L	H
L	H	H	L	X	X	X	X	X	X	L	X	H	L
L	H	H	L	X	X	X	X	X	X	H	X	L	H
L	H	H	H	X	X	X	X	X	X	X	L	H	L
L	H	H	H	X	X	X	X	X	X	X	H	L	H

H = HIGH voltage level. L = LOW voltage level. X = Don't care.

CD54/74AC151

CD54/74ACT151

MAXIMUM RATINGS, Absolute-Maximum Values:

DC SUPPLY-VOLTAGE (V_{CC})	-0.5 to 6 V
DC INPUT DIODE CURRENT, I_{IK} (for $V_i < -0.5$ V or $V_i > V_{CC} + 0.5$ V)	± 20 mA
DC OUTPUT DIODE CURRENT, I_{OK} (for $V_o < -0.5$ V or $V_o > V_{CC} + 0.5$ V)	± 50 mA
DC OUTPUT SOURCE OR SINK CURRENT per Output Pin, I_o (for $V_o > -0.5$ V or $V_o < V_{CC} + 0.5$ V)	± 50 mA
DC V_{CC} or GROUND CURRENT (I_{CC} or I_{GND})	± 100 mA*
POWER DISSIPATION PER PACKAGE (P_D):		
For $T_A = -55$ to $+100^\circ$ C (PACKAGE TYPE E)	500 mW
For $T_A = +100$ to $+125^\circ$ C (PACKAGE TYPE E)	Derate Linearly at 8 mW/ $^\circ$ C to 300 mW
For $T_A = -55$ to $+70^\circ$ C (PACKAGE TYPE M)	400 mW
For $T_A = +70$ to $+125^\circ$ C (PACKAGE TYPE M)	Derate Linearly at 6 mW/ $^\circ$ C to 70 mW
OPERATING-TEMPERATURE RANGE (T_A)	-55 to $+125^\circ$ C
STORAGE TEMPERATURE (T_{STG})	-65 to $+150^\circ$ C
LEAD TEMPERATURE (DURING SOLDERING):		
At distance $1/16 \pm 1/32$ in. (1.59 ± 0.79 mm) from case for 10 s maximum	$+265^\circ$ C
Unit inserted into PC board min. thickness $1/16$ in. (1.59 mm) with solder contacting lead tips only	$+300^\circ$ C

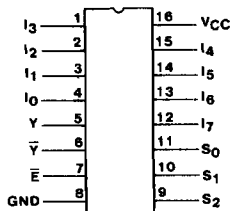
*For up to 4 outputs per device, add ± 25 mA for each additional output.

RECOMMENDED OPERATING CONDITIONS:

For maximum reliability, normal operating conditions should be selected so that operation is always within the following ranges:

CHARACTERISTICS	LIMITS		UNITS
	MIN.	MAX.	
Supply-Voltage Range, V_{CC} *: (For $T_A =$ Full Package-Temperature Range)			
AC Types	1.5	5.5	V
ACT Types	4.5	5.5	V
DC Input or Output Voltage, V_i, V_o	0	V_{CC}	V
Operating Temperature, T_A	-55	+125	$^\circ$ C
Input Rise and Fall Slew Rate, dt/dv			
at 1.5 V to 3 V (AC Types)	0	50	ns/V
at 3.6 V to 5.5 V (AC Types)	0	20	ns/V
at 4.5 V to 5.5 V (ACT Types)	0	10	ns/V

*Unless otherwise specified, all voltages are referenced to ground.



92CS - 38432

TERMINAL ASSIGNMENT

Technical Data
CD54/74AC151
CD54/74ACT151

STATIC ELECTRICAL CHARACTERISTICS: AC Series

CHARACTERISTICS	TEST CONDITIONS	V_{CC} (V)	AMBIENT TEMPERATURE (T_A) - °C						UNITS	
			+25		-40 to +85		-55 to +125			
			MIN.	MAX.	MIN.	MAX.	MIN.	MAX.		
High-Level Input Voltage V_{IH}		1.5	1.2	—	1.2	—	1.2	—	V	
		3	2.1	—	2.1	—	2.1	—		
		5.5	3.85	—	3.85	—	3.85	—		
Low-Level Input Voltage V_{IL}		1.5	—	0.3	—	0.3	—	0.3	V	
		3	—	0.9	—	0.9	—	0.9		
		5.5	—	1.65	—	1.65	—	1.65		
High-Level Output Voltage V_{OH}	V_{IH} or V_{IL}	-0.05	1.5	1.4	—	1.4	—	1.4	V	
		-0.05	3	2.9	—	2.9	—	2.9		
		-0.05	4.5	4.4	—	4.4	—	4.4		
		-4	3	2.58	—	2.48	—	2.4		
		-24	4.5	3.94	—	3.8	—	3.7		
		-75	5.5	—	—	3.85	—	—		
		-50	5.5	—	—	—	—	3.85		
Low-Level Output Voltage V_{OL}	V_{IH} or V_{IL}	0.05	1.5	—	0.1	—	0.1	—	V	
		0.05	3	—	0.1	—	0.1	—		
		0.05	4.5	—	0.1	—	0.1	—		
		12	3	—	0.36	—	0.44	—		
		24	4.5	—	0.36	—	0.44	—		
		75	5.5	—	—	—	1.65	—		
		50	5.5	—	—	—	—	1.65		
Input Leakage Current I_I	V_{CC} or GND		5.5	—	±0.1	—	±1	—	±1	μA
Quiescent Supply Current, MSI I_{CC}	V_{CC} or GND	0	5.5	—	8	—	80	—	160	μA

#Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation.

*Test verifies a minimum 50-ohm transmission-line-drive capability at +85°C, 75 ohms at +125°C.

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CD54/74AC151

CD54/74ACT151

STATIC ELECTRICAL CHARACTERISTICS: ACT Series

CHARACTERISTICS	TEST CONDITIONS		V _{CC} (V)	AMBIENT TEMPERATURE (T _a) - °C						UNITS	
				+25		-40 to +85		-55 to +125			
	V _I (V)	I _O (mA)		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.		
High-Level Input Voltage	V _{IH}		4.5 to 5.5	2	—	2	—	2	—	V	
Low-Level Input Voltage	V _{IL}		4.5 to 5.5	—	0.8	—	0.8	—	0.8	V	
High-Level Output Voltage	V _{OH}	V _{IH} or V _{IL} #,*	-0.05	4.5	4.4	—	4.4	—	4.4	—	V
			-24	4.5	3.94	—	3.8	—	3.7	—	
			-75	5.5	—	—	3.85	—	—	—	
			-50	5.5	—	—	—	—	3.85	—	
Low-Level Output Voltage	V _{OL}	V _{IH} or V _{IL} #,*	0.05	4.5	—	0.1	—	0.1	—	0.1	V
			24	4.5	—	0.36	—	0.44	—	0.5	
			75	5.5	—	—	—	1.65	—	—	
			50	5.5	—	—	—	—	—	1.65	
Input Leakage Current	I _I	V _{CC} or GND	5.5	—	±0.1	—	±1	—	±1	μA	
Quiescent Supply Current, MSI	I _{CC}	V _{CC} or GND	0	5.5	—	8	—	80	—	160	μA
Additional Quiescent Supply Current per Input Pin TTL Inputs High 1 Unit Load	ΔI _{CC}	V _{CC} -2.1	4.5 to 5.5	—	2.4	—	2.8	—	3	mA	

#Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation.

* Test verifies a minimum 50-ohm transmission-line-drive capability at +85°C, 75 ohms at +125°C.

ACT INPUT LOADING TABLE

INPUT	UNIT LOAD*
I (All)	1
E	1
S	1

*Unit load is ΔI_{CC} limit specified in Static Characteristics Chart, e.g., 2.4 mA max. @ 25°C.

Technical Data
CD54/74AC151
CD54/74ACT151

SWITCHING CHARACTERISTICS: AC Series; $t_r, t_f = 3 \text{ ns}$, $C_L = 50 \text{ pF}$

CHARACTERISTICS	SYMBOL	V_{CC} (V)	AMBIENT TEMPERATURE (T_A) - °C				UNITS
			-40 to +85		-55 to +125		
			MIN.	MAX.	MIN.	MAX.	
Propagation Delays: Any Data to Y	t_{PLH}	1.5	—	152	—	169	ns
	t_{PHL}	3.3*	4.9	17.1	4.7	18.9	
		5†	3.5	12.3	3.4	13.5	
Any Data to \bar{Y}	t_{PLH}	1.5	—	169	—	186	ns
	t_{PHL}	3.3	5.4	19	5.2	20.9	
		5	3.8	13.5	3.7	14.9	
Any Select to Y	t_{PLH}	1.5	—	207	—	228	ns
	t_{PHL}	3.3	6.6	23.2	6.4	25.5	
		5	4.7	16.5	4.6	18.2	
Any Select to \bar{Y}	t_{PLH}	1.5	—	223	—	245	ns
	t_{PHL}	3.3	7.1	24.9	6.9	27.4	
		5	5.1	17.8	4.9	19.6	
Any \bar{E} nable to Y	t_{PLH}	1.5	—	139	—	153	ns
	t_{PHL}	3.3	4.4	15.5	4.3	17.1	
		5	3.1	11.1	3.1	12.2	
Any \bar{E} nable to \bar{Y}	t_{PLH}	1.5	—	153	—	169	ns
	t_{PHL}	3.3	4.9	17.2	4.7	18.9	
		5	3.5	12.3	3.4	13.5	
Power Dissipation Capacitance	$C_{PD}\S$	—	120 Typ.		120 Typ.		pF
Input Capacitance	C_i	—	—	10	—	10	pF

*3.3 V: min. is @ 3.6 V
max. is @ 3 V

†5 V: min. is @ 5.5 V
max. is @ 4.5 V

§ C_{PD} is used to determine the dynamic power consumption, per device.

$$P_D = V_{CC}^2 f_i (C_{PD} + C_L) \text{ where } f_i = \text{input frequency}$$

$$C_L = \text{output load capacitance}$$

$$V_{CC} = \text{supply voltage.}$$

SWITCHING CHARACTERISTICS: ACT Series; $t_r, t_f = 3 \text{ ns}$, $C_L = 50 \text{ pF}$

CHARACTERISTICS	SYMBOL	V_{CC} (V)	AMBIENT TEMPERATURE (T_A) - °C				UNITS
			-40 to +85		-55 to +125		
			MIN.	MAX.	MIN.	MAX.	
Propagation Delays: Any Data to Y	t_{PLH}	5*	4	14.1	3.9	15.5	ns
	t_{PHL}						
Any Data to \bar{Y}	t_{PLH}	5	4.4	15.4	4.2	16.9	ns
	t_{PHL}						
Any Select to Y	t_{PLH}	5	5.2	18.4	5.1	20.2	ns
	t_{PHL}						
Any Select to \bar{Y}	t_{PLH}	5	5.6	19.6	5.4	21.6	ns
	t_{PHL}						
Any \bar{E} nable to Y	t_{PLH}	5	3.1	11	3	12.1	ns
	t_{PHL}						
Any \bar{E} nable to \bar{Y}	t_{PLH}	5	3.5	12.3	3.4	13.5	ns
	t_{PHL}						
Power Dissipation Capacitance	$C_{PD}\S$	—	120 Typ.		120 Typ.		pF
Input Capacitance	C_i	—	—	10	—	10	pF

*5 V: min. is @ 5.5 V
max. is @ 4.5 V

§ C_{PD} is used to determine the dynamic power consumption, per package.

$$P_D = V_{CC}^2 f_i (C_{PD} + C_L) + V_{CC} \Delta I_{CC} \text{ where } f_i = \text{input frequency}$$

$$C_L = \text{output load capacitance}$$

$$V_{CC} = \text{supply voltage.}$$

CD54/74AC151 CD54/74ACT151

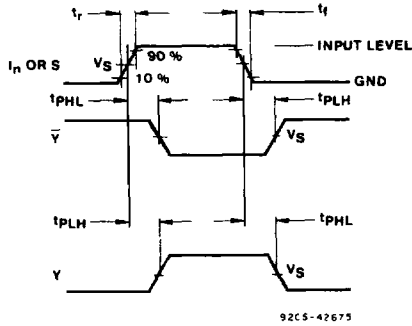


Fig. 1 - Inputs or select to output propagation delays.

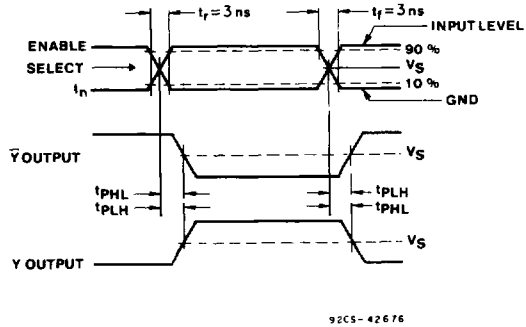


Fig. 2 - Enable to output propagation delays.

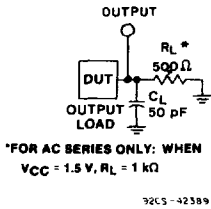


Fig. 3 - Test circuit.

	CD54/74AC	CD54/74ACT
Input Level	V_{CC}	3 V
Input Switching Voltage, V_S	$0.5 V_{CC}$	1.5 V
Output Switching Voltage, V_S	$0.5 V_{CC}$	$0.5 V_{CC}$